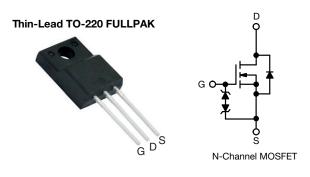
SiHA11N80AE

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	850				
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.391				
Q _g max. (nC)	42				
Q _{gs} (nC)	6				
Q _{gd} (nC)	12				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low effective capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Integrated Zener diode ESD protection
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free and halogen-free	SiHA11N80AE-GE3

ABSOLUTE MAXIMUM RATINGS (T	_C = 25 °C, un	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	800	v
Gate-source voltage			V _{GS}	± 30	v
Continuous drain current (T ₁ = 150 °C) ^e	V _{GS} at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$		8	
Continuous drain current $(1_j = 150^{\circ} C)^{\circ}$	VGS at TO V	T _C = 100 °C	I _D	5	А
Pulsed drain current ^a			I _{DM}	22	
Linear derating factor				0.25	W/°C
Single pulse avalanche energy ^b			E _{AS}	88	mJ
Maximum power dissipation			PD	31	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope $T_J = 125 \text{ °C}$		dv/dt	70	V/ns	
Reverse diode dv/dt ^d			2	v/ns	
Soldering recommendations (peak temperature) ^c For 10 s		For 10 s		260	°C
Mounting torque, M3 screw				0.6	Nm

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 2.5 A

c. 1.6 mm from case

d. $I_{SD} \le I_D$, di/dt = 100 A/µs, starting T_J = 25 °C e. Limited by maximum junction temperature

S19-0956-Rev. A, 11-Nov-2019

1

ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishav.com/doc?91000



COMPLIANT HALOGEN FREE



THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP.		MAX.	MAX.		UNIT	
Maximum junction-to-ambient	R _{thJA}	-		65		°C (M)		
Maximum junction-to-case (drain)	R _{thJC}	- 4			°C/W			
SPECIFICATIONS (T _J = 25 $^{\circ}$ C,	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static					•	•	•	
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 µA	800	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I _D = 1 mA	-	0.8	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	$V_{GS}, I_D = 2$	250 µA	2	-	4	V
		V _{GS} = ± 20 V		-	-	± 10		
Gate-source leakage	I _{GSS}	\ \	V _{GS} = ± 30	V	-	-	± 50	μA
	1	V _{DS} =	800 V, V _G	_S = 0 V	-	-	1	
Zero gate voltage drain current	IDSS	$V_{DS} = 800 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ $V_{DS} = 640 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		∕, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	١ _D	₀ = 5.5 A	-	0.391	0.450	Ω
Forward transconductance ^a	9 _{fs}	V _{DS} =	= 30 V, I _D =	= 5.5 A	-	2.9	-	S
Dynamic								
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	804	-	-	
Output capacitance	C _{oss}			-	34	-		
Reverse transfer capacitance	C _{rss}			-	5	-		
Effective output capacitance, energy related ^a	C _{o(er)}	N 01	(+= 400) (-	27	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		-	162	-		
Total gate charge	Qg				-	28	42	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$I_{\rm D} = 5.5$	A, V _{DS} = 640 V	-	6	-	nC
Gate-drain charge	Q _{gd}				-	12	-	
Turn-on delay time	t _{d(on)}				-	13	26	
Rise time	t _r	V _{DD} =	640 V, I _D =	= 5.5 A,	-	15	30	
Turn-off delay time	t _{d(off)}	V _{GS} =	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	25	50	ns
Fall time	t _f	1		-	27	54		
Gate input resistance	R _g	f = 1 MHz, open drain		0.7	1.5	3	Ω	
Drain-Source Body Diode Characterist	ics							
Continuous source-drain diode current	IS	MOSFET symbol showing the integral reverse p - n junction diode		-	-	8		
Pulsed diode forward current	I _{SM}			-	-	22	A	
Diode forward voltage	V _{SD}	T _J = 25 °C	, I _S = 5.5 A	A, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}				-	278	556	ns
Reverse recovery charge	Q _{rr}		$^{\circ}$ C, $I_{F} = I_{S}$		-	2.9	5.8	μC
Reverse recovery current	I _{RRM}		100 A/µs, \	$v_{\rm R} = 25 V$	-	17	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 V to 480 V V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 V to 480 V V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

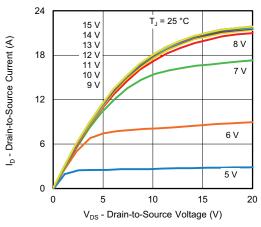


Fig. 1 - Typical Output Characteristics

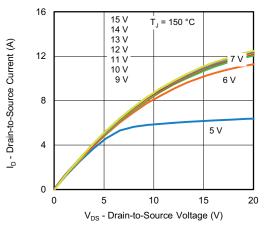


Fig. 2 - Typical Output Characteristics

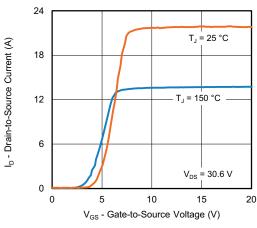


Fig. 3 - Typical Transfer Characteristics

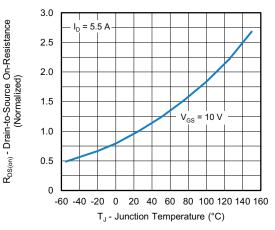


Fig. 4 - Normalized On-Resistance vs. Temperature

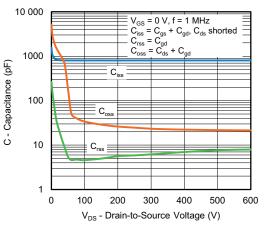


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

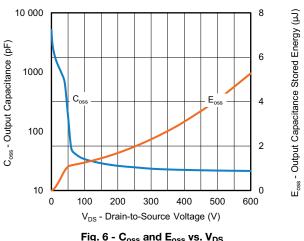


Fig. 6 - Coss and Eoss vs. VDS

S19-0956-Rev. A, 11-Nov-2019

3 For technical questions, contact: hvm@vishay.com Document Number: 92295

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



SiHA11N80AE

Vishay Siliconix

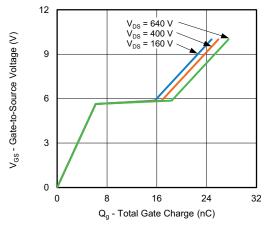


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

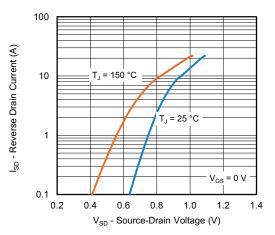


Fig. 8 - Typical Source-Drain Diode Forward Voltage

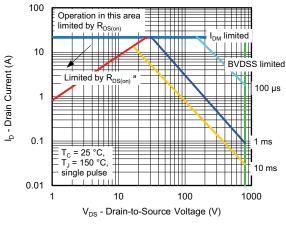


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

4

For technical questions, contact: <u>hvm@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>

(F) the constraints of the second se

10

Fig. 10 - Maximum Drain Current vs. Case Temperature

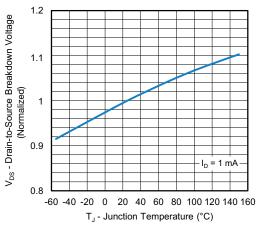


Fig. 11 - Temperature vs. Drain-to-Source Voltage



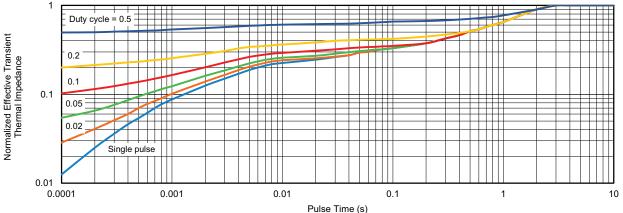


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

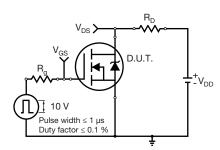


Fig. 13 - Switching Time Test Circuit

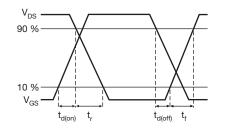


Fig. 14 - Switching Time Waveforms

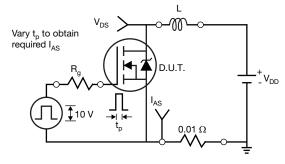
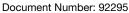


Fig. 15 - Unclamped Inductive Test Circuit

S19-0956-Rev. A, 11-Nov-2019

5



ince, Junction-to-Case

Fig. 16 - Unclamped Inductive Waveforms

 I_{AS}

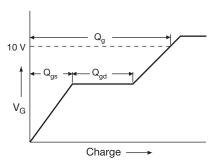
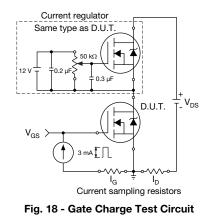


Fig. 17 - Basic Gate Charge Waveform



For technical questions, contact: <u>hvm@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



Peak Diode Recovery dv/dt Test Circuit

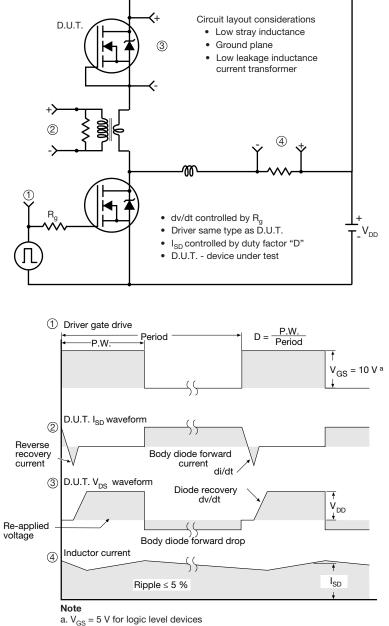


Fig. 19 - For N-Channel

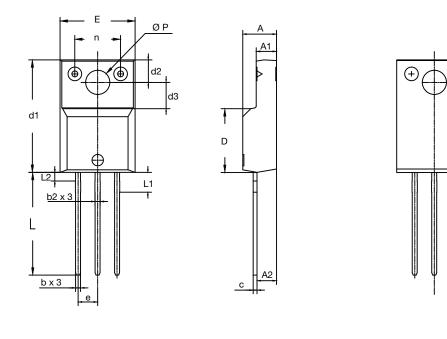
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?92295</u>.

 \oplus



Vishay Siliconix

TO-220 FULLPAK Thin Lead





	DIMENSIONS						
SYMBOL	MILLIN	IETERS	INC	HES			
	MIN.	MAX.	MIN.	MAX.			
А	4.30	4.70	0.169	0.185			
A1	2.50	2.90	0.098	0.114			
A2	2.50	2.70	0.098	0.106			
b	0.60	0.80	0.024	0.031			
b2	0.60	0.90	0.024	0.035			
С	-	0.60	-	0.024			
D	8.30	8.70	0.327	0.342			
d1	14.70	15.30	0.579	0.602			
d2	2.90	3.10	0.114	0.122			
d3	3.40	3.60	0.134	0.142			
E	9.70	10.30	0.382	0.406			
е	2.50	2.70	0.098	0.106			
L	13.40	13.80	0.528	0.543			
L1	2.50	2.80	0.098	0.110			
L2	-	1.20	-	0.047			
n	6.05	6.15	0.238	0.242			
ØP	3.00	3.40	0.118	0.134			

Revision: 12-Sep-16

1

Document Number: 62649



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Vishay: SIHA11N80AE-GE3